

SLLS445A - DECEMBER 2000 - REVISED SEPTEMBER 2011

MuxIt[™] RECEIVER-DESERIALIZER

Check for Samples: SN65LVDS152

FEATURES

•	A Member of the Muxlt™ Serializer- Deserializer Building-Block Chip Family		SN65LVDS152DA (Marked as 65LVDS152) (TOP VIEW)	
•	Supports Deserialization of One Serial Link Data Channel Input at Rates up to 200 Mbps	DI+ [E °°
•	PLL Lock/Valid Input Provided to Enable Parallel Data and Clock Outputs	DI- [GND [3 30	[мсі–
•	Cascadable With Additional SN65LVDS152 Muxlt Receiver-Deserializers for Wider Parallel Output Data Channel Widths	LCI+ [LCI- [GND [5 28 6 27	I MCI+ GND DCO
•	LVDS Compatible Differential Inputs and Outputs Meet or Exceed the Requirements of ANSI TIA/EIA-644-A	CO_EN [V _{CC} [GND [8 25 9 24	DO-9 DO-8 DO-7
•	LVDS Input and Output ESD Protection Exceeds 12 kV HBM	V _{CC} [V _{CC} [GND [11 22	DO-6 DO-5 DO-4
•	LVTTL Compatible Inputs for Lock/Valid and Enables Are 5-V Tolerant	GND GND EN [13 20	DO-3 DO-2
•	Operates With 3.3-V Supply	co- [15 18	DO-1
•	Packaged in 32-Pin DA Thin Shrink Small-Outline Package With 26-Mil Terminal Pitch	co+ [16 17	DO-0

DESCRIPTION

MuxIt is a family of general-purpose, multiple-chip building blocks for implementing parallel data serializers and deserializers. The system allows for wide parallel data to be transmitted through a reduced number of transmission lines over distances greater than can be achieved with a single-ended (e.g., LVTTL or LVCMOS) data interface. The number of bits multiplexed per transmission line is user selectable, allowing for higher transmission efficiencies than with other existing fixed ratio solutions. MuxIt utilizes the LVDS (TIA/EIA-644-A) low voltage differential signaling technology for communications between the data source and data destination.

The MuxIt family initially includes three devices supporting simplex communications: the SN65LVDS150 phase locked loop frequency multiplier, the SN65LVDS151 serializer-transmitter, and the SN65LVDS152 receiver-deserializer.

The SN65LVDS152 consists of three LVDS differential transmission line receivers, an LVDS differential transmission line driver, a 10-bit serial-in/parallel-out shift register, plus associated input and output buffers. It receives serialized data over an LVDS transmission line link, deserializes (demultiplexes) it, and delivers it on parallel data outputs, DO-0 through DO-9. Data received over the link is clocked at a factor of M times the original parallel data frequency. The multiplexing ratio M, or number of bits per data clock cycle, is programmed with configuration pins (M1 \rightarrow M5) on the companion SN65LVDS150 MuxIt programmable PLL frequency multiplier. Up to 10 bits of data may be deserialized and output by each SN65LVDS152. Two or more SN65LVDS152 units may be connected in series (cascaded) to accommodate wider parallel data paths for higher serialization values. The range of multiplexing ratio M supported by the SN65LVDS150 MuxIt programmable PLL frequency multiplier is between 4 and 40. Table 1 shows some of the combinations of LCI and MCI supported by the SN65LVDS150 MuxIt programmable PLL frequency multiplier.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet. MuxIt is a trademark of Texas Instruments.

SLLS445A - DECEMBER 2000 - REVISED SEPTEMBER 2011





These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.

DECRIPTION (CONTINUED)

Data is serially shifted into the SN65LVDS152 shift register on the falling edges of the M-clock input (MCI). The data is latched out in parallel from the SN65LVDS152 shift register on the second rising edge after the first falling edge of the M-clock following a rising edge of the link clock input (LCI). The SN65LVDS152 includes LVDS differential line receivers for both the serialized link data stream (DI) and link clock (LCI). High-speed signals from the SN65LVDS150 MuxIt programmable frequency multiplier (MCI), plus the input and output for cascaded data (DI, CO) are carried over differential connections to minimize skew and jitter. Examples of operating waveforms for values of M = 4 and M = 10 are provided in Figure 1.

The enable input (EN) along with internal power-on reset (POR) controls the outputs. When Vcc is below 1.5 volts, or when EN is low, outputs are disabled. When V_{CC} is above 3 V and EN is high, outputs are enabled and operating to specifications.

Parallel data bits are output from DO-n outputs in an order dependent on the value of the multiplexing ratio (frequency multiplier value) M. For values of M from 4 through 10, the cascade output (CO_{\pm}) is not used, and only the top M parallel outputs (DO–9 through DO–[10-M]) are used. The data bit output on DO-9 corresponds to the data bit input on DI–[M–1] of the SN65LVDS151 serializer. Likewise, the data bit output on DO-[10-M] will correspond to the data bit input on DI–0 of the SN65LVDS151 serializer.

For values of M greater than 10, the cascade output (CO \pm) is used to connect multiple SN65LVDS152 deserializers. In this case the higher-order unit(s) output 10 bits each of the highest numbered bits that are input into the SN65LVDS151 serializer(s). The lowest numbered input bits are output on the lowest-order SN65LVDS152 deserializer in descending order from output DO–9. The number of bits is equal to M mod(10). Table 2 reflects this information, where X = M mod(10)

Table 1. Example Combinations of LCI and MCI Supported by the SN65LVDS150 MuxIt Programmable PLL Frequency Multiplier

	LCI,	MHz	MCI,	MHz
м	MINIMUM	MAXIMUM	MINIMUM	MAXIMUM
4	5	50	20	200
10	5	20	50	200
20	5	10	100	200
40	5	5	200	200

	X = 1	X = 2	X = 3	X = 4	X = 5	X = 6	X = 7	X = 8	X = 9	X = 0
DO-9 output bit	DI-0	DI-1	DI-2	DI-3	DI-4	DI-5	DI-6	DI-7	DI-8	DI-9
DO-8 output bit	Invalid	DI-0	DI-1	DI-2	DI-3	DI-4	DI-5	DI-6	DI-7	DI-8
DO-7 output bit	Invalid	Invalid	DI-0	DI-1	DI-2	DI-3	DI-4	DI-5	DI-6	DI-7
DO-6 output bit	Invalid	Invalid	Invalid	DI-0	DI-1	DI-2	DI-3	DI-4	DI-5	DI-6
DO-5 output bit	Invalid	Invalid	Invalid	Invalid	DI-0	DI-1	DI-2	DI-3	DI-4	DI-5
DO-4 output bit	Invalid	Invalid	Invalid	Invalid	Invalid	DI-0	DI-1	DI-2	DI-3	DI-4
DO-3 output bit	Invalid	Invalid	Invalid	Invalid	Invalid	Invalid	DI-0	DI-1	DI-2	DI-3
DO-2 output bit	Invalid	DI-0	DI-1	DI-2						
DO-1 output bit	Invalid	DI-0	DI-1							
DO-0 output bit	Invalid	DI-0								

Table 2. Output Data Bits as a Function of Multiplier Value M



SLLS445A – DECEMBER 2000 – REVISED SEPTEMBER 2011

Additional information on output bit ordering in cascaded applications can be found in the MuxIt Application Report.

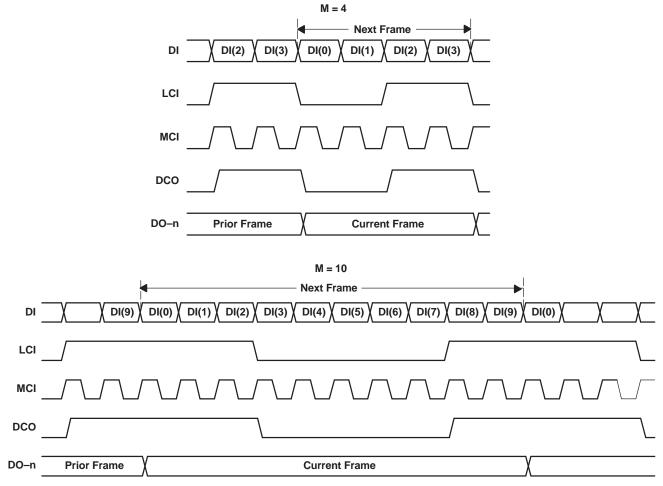


Figure 1. Operating Waveform Examples

SLLS445A – DECEMBER 2000 – REVISED SEPTEMBER 2011

www.ti.com

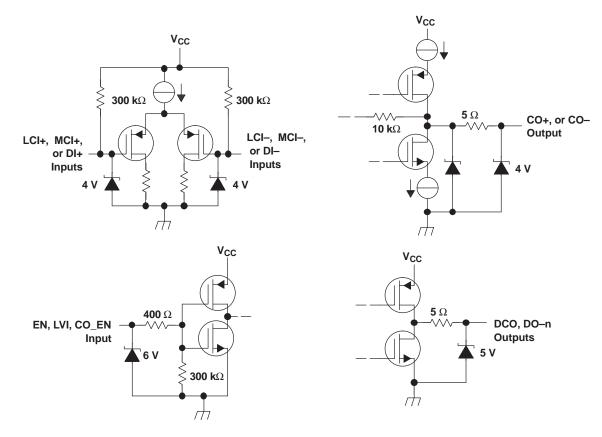
LCI - DCO **Control Logic** MCI EN LVI CO_EN DI DO-9 DO-8 DO-7 ♦ DO-6 **Output Latches** ↓ Shift Register DO-5 ▼ DO-4 DO-3 DO-2 DO-1 4 DO-0 Ŵ со

FUNCTIONAL BLOCK DIAGRAM



SLLS445A - DECEMBER 2000 - REVISED SEPTEMBER 2011

EQUIVALENT INPUT AND OUTPUT SCHEMATIC DIAGRAMS



Terminal Functions

TERMINAL NAME NO.		I/O	LEVEL	DESCRIPTION	
		1/0	LEVEL	DESCRIPTION	
CO–, CO+	15, 16	Output	LVDS	Cascade output. This is used to connect to additional SN65LVDS152 units when the multiplexing ratio M (and M-clock) value is greater than 10.	
CO_EN	7	Input	LVTTL	Cascade output enable. Used to control the CO output. A high-level input enables the CO output, a low-level input disables the CO output.	
DCO	27	Output	LVTTL	Data clock output. This is the recovered (original frequency) clock that is synchronized the deserialized parallel data.	
DI+, DI–	1, 2	Input	LVDS	Link data input. This is the data being received from the source end of the serialized link. Also used for cascade data input from additional SN65LVDS152 units when the multiplexing ratio M value is greater than 10.	
EN	14	Input	LVTTL	Enable. Used to control overall device operation. A high-level input enables the device. A low-level input disables the device by resetting the internal latches and forcing the CO and LVTTL outputs to a high-impedance state.	
GND	3, 6, 9, 12, 13, 28	Power	NA	Circuit ground	
LCI+, LCI–	4, 5	Input	LVDS	Link clock input. This is the data block synchronization clock received from the source end of the serialized link.	
LVI	31	Input	LVTTL	Lock/valid input. This is a signal required for proper MuxIt system operation. It is to be directly connected to the LVO output of an SN65LVDS150. It is used to inhibit the operation of this device until after the PLL has stabilized. A low level input disables the data and clock outputs, a high level input enables the outputs	
MCI+, MCII–	29,30	Input	LVDS	M-clock input. This is the high frequency multiplied clock input from the local PLL frequency multiplier. It synchronizes the reception of the link data	
DOI-0I-DOI-9	17-26	Output	LVTTL	Parallel data outputs. Data from the serial shift register is transferred to the output data latches in synchronization with the rising edge of LCI.	
V _{CC}	8, 10, 11, 32	Power	NA	Supply voltage	

Copyright © 2000–2011, Texas Instruments Incorporated

SLLS445A-DECEMBER 2000-REVISED SEPTEMBER 2011



www.ti.com

ABSOLUTE MAXIMUM RATINGS

over operating free-air temperature range (unless otherwise noted)⁽¹⁾

		UNIT
Supply voltage range, V _{CC} ⁽²⁾		-0.5 V to 4 V
Input voltago rongo	EN, LVI, CO_EN	–0.5 V to 5.5 V
Input voltage range	LCI±, MCI±, DI±, CO±	–0.5 V to 4 V
Electrostatic discharge, human body model ⁽³⁾	LCI±, MCI±, DI±, CO±, and GND	±12 kV
Electrostatic discharge, numan body model	All pins	±2 kV
Charged-device model ⁽⁴⁾	All pins	±500 V
Continuous power dissipation		See Dissipation Rating Table
Storage temperature range		–65°C to 150°C
Lead temperature 1,6 mm (1/16 inch) from case for	10 seconds	260°C

(1) Stresses beyond those listed under *absolute maximum ratings* may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under *recommended operating* conditions is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

All voltage values, except differential I/O bus voltages, are with respect to network ground terminal. (2)

Tested in accordance with JEDEC Standard 22, Test Method A114-B. Tested in accordance with JEDEC Standard 22, Test Method C101. (3)

(4)

DISSIPATION RATING TABLE

PACKAGE	T _A ≤ 25°C	DERATING FACTOR	T _A = 85°C
	POWER RATING	ABOVE $T_A = 25^{\circ}C$	POWER RATING
DA	1453 mW	11.6 mW/°C	756 mW

RECOMMENDED OPERATING CONDITIONS

			MIN	NOM	MAX	UNIT
V_{CC}	Supply voltage		3	3.3	3.6	V
VIH			2		V _{CC}	V
VIL	Low-level input voltage	EN, LVI, CO_EN			0.8	V
$ V_{ID} $	Magnitude of differential input voltage		0.1		0.6	V
V _{IC}	Common-mode input voltage	LCI±, MCI±, DI±	$\frac{ V_{ID} }{2}$		$2.4 - \frac{ V_{ID} }{2}$	V
					V _{CC} – 0.8	V
T _A	Operating free-air temperature		40		85	°C

TIMING REQUIREMENTS

	PARAMETERS	TEST CONDITIONS	MIN	MAX	UNIT
t _{su(1)}	Clock setup time, MCI↓ before LCI↑		0		ns
t _{su(2)}	Clock setup time, LCI↑ before MCI↓	See Figure 2	1		ns
t _{su(3)}	Link data setup time, DI before MCI↓		0.3		ns
t _{h(3)}	Link data hold time, DI after MCI↓	See Figure 3	0.5		ns



SN65LVDS152

SLLS445A - DECEMBER 2000 - REVISED SEPTEMBER 2011

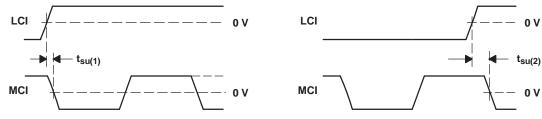


Figure 2. Link Clock Input and M-Clock Setup Time Waveforms

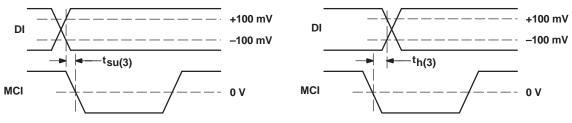


Figure 3. Input Data and M-Clock Setup and Hold Time Waveforms

ELECTRICAL CHARACTERISTICS

over recommended operating conditions (unless otherwise noted)

	PARAMETER		TEST CONDITIONS	MIN	TYP ⁽¹⁾	MAX	UNIT	
V _{ITH+}	Positive-going differential input voltage threshold Negative-going differential input voltage threshold					100		
V _{ITH-}	Negative-going differential inp	ut voltage threshold	See Figure 4	-100			mV	
V _{OD(SS)}	Steady-state differential output voltage magnitude			247	340	454	mV	
Δ V _{OD(SS)}			$R_L = 100 \Omega$, $V_{ID} = \pm 100 mV$, See Figure 5 and Figure 6	-50		50	mV	
V _{OC(SS)}	Steady-stade common-mode	output voltage		1.125		1.375	V	
$\Delta V_{OC(SS)}$	Change in steady-state comm voltage between logic states	non-mode output	See Figure 7	-50		50	mV	
V _{OC(PP)}	Peak-to-peak change commo	n-mode output voltage			50	150	mV	
V _{OH}	High-level output voltage	D0 - D00	$I_{OH} = -8 \text{ mA}$	2.4				
V _{OL}	Low-level output voltage	DO–n, DCO	I _{OL} = 8 mA			0.4	V	
			Enabled, $R_L = 100 \Omega$,		14	25		
			Disabled		0.5	1		
I _{CC}	Supply current				35	60	mA	
			$V_{I} = 0 V$	-2		-20		
l _l	Input current	LCI, MCI, DI inputs	V ₁ = 2.4 V	-1.2			μA	
I _{ID}	Differential input current	LCI, MCI, DI inputs	$V_{IC} = 0.05 \text{ V to } 2.35 \text{ V}, V_{ID} = \pm 0.1 \text{ V}$	-2		2	μA	
I _{I(OFF)}	Power-off input current	LCI, MCI, DI inputs	$V_{CC} = 0 V$, $V_{I} = 3.6 V$			20	μA	
I _{IH}	High-level input current	EN, LVI, CO_EN	V _{IH} = 2 V			20	μA	
I _{IL}	Low-level input current	EN, LVI, CO_EN	V _{IL} = 0.8 V			10	μA	
		00	V_{O+} or $V_{O-} = 0 V$	-10		10	mA	
l _{os}	Short-circuit output current	со	$V_{OD} = 0 V$	-10		10	mA	
	High-impedance output	CO		-5		5		
l _{oz}	current	DO-n, DCO	$V_{O} = 0 V \text{ or } V_{CC}$	-5		5	μA	
I _{O(OFF)}	Power-off output current	CO	$V_{CC} = 1.5 V$, $V_{O} = 3.6 V$	-5		5	μA	
CI	Input capacitance	LCI, MCI, DI inputs	V _{ID} = (0.4sin(4E6πt) + 0.5) V		3		pF	

(1) All typical values are at T_A = 25°C and with V_{CC} = 3.3 V.

SLLS445A - DECEMBER 2000 - REVISED SEPTEMBER 2011

TEXAS INSTRUMENTS

www.ti.com

SWITCHING CHARACTERISTICS

over recommended operating conditions (unless otherwise noted)

	PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
t _{d(1)}	Propagation delay time, LCI↑ to DCO↑			2	3	
t _{d(2)}	Delay time, MCI↑ to DO-n			3.3	5.5	
t _{su(4)}	Set-up time, DO-n valid to DCO↑	See Figure 8	5			ns
t _{h(4)}	Hold time, DCO↑ to DO-n valid		5			
t _{d(3)}	Delay time, MCI↓ to CO	See Figure 9		2.9	4.5	ns
	Differential output signal rise time, CO	$\label{eq:RL} \begin{array}{l} R_{L} = 100 \ \Omega, \ C_{L} = 10 \ pF, \\ \text{See Figure 10} \end{array}$	0.3	0.8	1.5	
t _r	Output signal rise time, DCO, DO-n	C _L = 10 pF, See Figure 11		0.6	1.5	ns
	Differential output signal fall time, CO	$R_{L} = 100 \ \Omega, C_{L} = 10 \ pF,$ See Figure 10	0.3	0.8	1.5	
t _f	Output signal fall time, DCO, DO-n	C _L = 10 pF, See Figure 11		0.6	1.5	ns
t _{sk(p)}	Pulse skew (t _{PHL} - t _{PLH}), CO	$R_L = 100 \Omega, C_L = 10 pF,$ See Figure 10		0	300	ps
t _{PZH}	Propagation delay time, high-impedance to high-level output (DCO only)			5	15	
t _{PZL}	Propagation delay time, high-impedance to low-level output			5	15	ns
t _{PHZ}	Propagation delay time, high-level to high-impedance output	See Figure 12		5	15	-
t _{PLZ}	Propagation delay time, low-level to high-impedance output			6	15	
t _{PZH}	Propagation delay time, high-impedance to high-level output (DCO only)			5	15	
t _{PZL}	Propagation delay time, high-impedance to low-level output	- LVI to DCO, DO-n C ₁ = 10 pF,		5	15	ns
t _{PHZ}	Propagation delay time, high-level to high-impedance output	See Figure 12		5	15	-
t _{PLZ}	Propagation delay time, low-level to high-impedance output			5	15	



SLLS445A – DECEMBER 2000 – REVISED SEPTEMBER 2011

PARAMETER MEASUREMENT INFORMATION

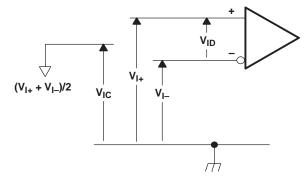
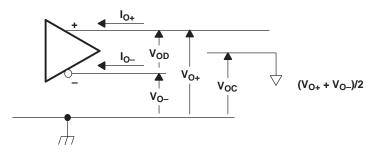


Figure 4. Receiver Voltage Definitions

APPLIED VOLTAGES			
VI+	V _I _	V _{ID}	V _{IC}
1.25 V	1.15 V	100 mV	1.2 V
1.15 V	1.25 V	–100 mV	1.2 V
2.4 V	2.3 V	100 mV	2.35 V
2.3 V	2.4 V	–100 mV	2.35 V
0.1 V	0 V	100 mV	0.05 V
0 V	0.1 V	–100 mV	0.05 V
1.5 V	0.9 V	600 mV	1.2 V
0.9 V	1.5 V	–600 mV	1.2 V
2.4 V	1.8 V	600 mV	2.1 V
1.8 V	2.4 V	–600 mV	2.1 V
0.6 V	0 V	600 mV	0.3 V
0 V	0.6 V	–600 mV	0.3 V





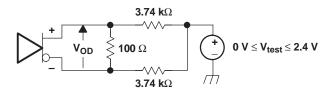
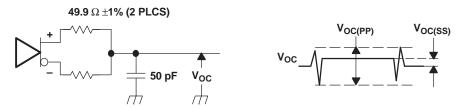


Figure 6. V_{OD} Test Circuit

SLLS445A – DECEMBER 2000 – REVISED SEPTEMBER 2011



A. All input pulses are supplied by a generator having the following characteristics: t_r or t_f≤ 1 ns, pulse repetition rate (PRR) = 0.5 Mpps, Pulse width = 500 ± 10 ns . C_L includes instrumentation and fixture capacitance within 0,06 m of the D.U.T. The measurement of V_{OC(PP)} is made on test equipment with a -3 dB bandwidth of at least 5 GHz.

Figure 7. Test Circuit and Definitions for the Driver Common-Mode Output Voltage

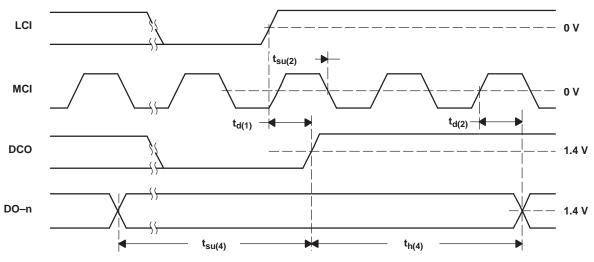


Figure 8. Data Clock and Data Output Timing Waveforms

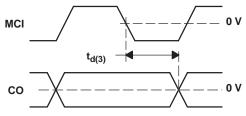
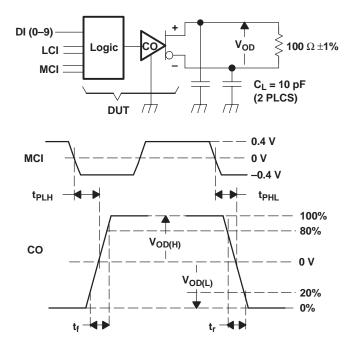


Figure 9. MCI to CO Timing Waveforms

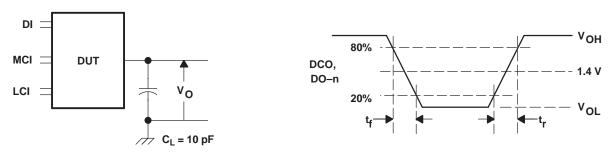


SLLS445A – DECEMBER 2000 – REVISED SEPTEMBER 2011



A. All input pulses are supplied by a generator having the following characteristics: t_r or $t_f \le 1$ ns, pulse repetition rate (PRR) = 100 Mpps, Pulse width = 5 ± 0.1 ns . C_L includes instrumentation and fixture capacitance within 0,06 m of the D.U.T.

Figure 10. Test Circuit, Timing, and Voltage Definitions for the Differential Output Signal



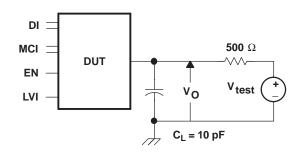
A. All input pulses are supplied by a generator having the following characteristics: t_r or $t_r \le 1$ ns, MCI pulse repetition rate (PRR) = 50 Mpps, Pulse width = 10 ± 0.2 ns . LCI pulse repetition rate (PRR) = 5 Mpps, pulsewidth = 100 ± 2 ns. C_L includes instrumentation and fixture capacitance within 0,06 m of the D.U.T.

Figure 11. Timing Test Circuit and Waveforms

SLLS445A – DECEMBER 2000 – REVISED SEPTEMBER 2011



www.ti.com



NOTE: $V_{\text{TEST}} = 2.5 \text{ V}$ for t_{PZL} or t_{PLZ} , $V_{\text{TEST}} = 0 \text{ V}$ for t_{PZH} or t_{PHZ} . All input pulses are supplied by a generator having the following characteristics: t_{f} or $t_{f} \le 1$ ns, pulse repetition rate (PRR) = 0.5 Mpps, pulse width = 500 ±10 ns . C_{L} includes instrumentation and fixture capacitance within 0,06 m of the D.U.T.

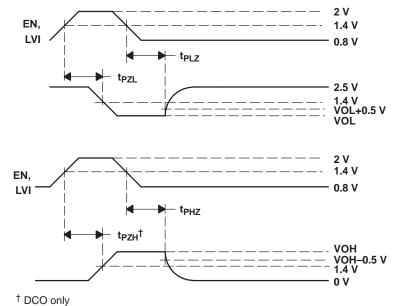


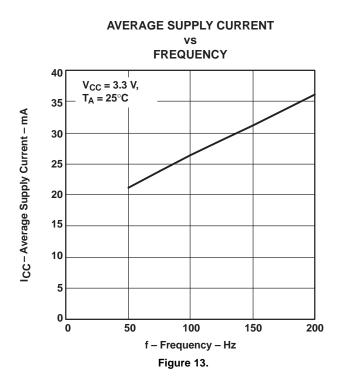
Figure 12. Enable/Disable Time Test Circuit and Waveforms



AS

STRUMENTS

TYPICAL CHARACTERISTICS



REVISION HISTORY

Changes from Original (December 2000) to Revision A

www.ti.com

Page



PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead finish/ Ball material (6)	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)	Samples
SN65LVDS152DA	ACTIVE	TSSOP	DA	32	46	RoHS & Green	NIPDAU	Level-2-260C-1 YEAR	-40 to 85	65LVDS152	Samples
SN65LVDS152DAR	ACTIVE	TSSOP	DA	32	2000	RoHS & Green	NIPDAU	Level-2-260C-1 YEAR	-40 to 85	65LVDS152	Samples

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

⁽²⁾ RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

⁽³⁾ MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

⁽⁴⁾ There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

⁽⁵⁾ Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

⁽⁶⁾ Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

Important Information and Disclaimer:The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.



PACKAGE OPTION ADDENDUM

10-Dec-2020



TAPE AND REEL INFORMATION





QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal	

Device	Package Type	Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
SN65LVDS152DAR	TSSOP	DA	32	2000	330.0	24.4	8.6	11.5	1.6	12.0	24.0	Q1



PACKAGE MATERIALS INFORMATION

5-Dec-2023



*All dimensions are nominal

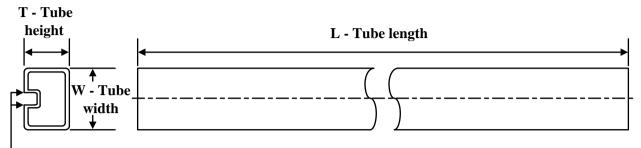
Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)	
SN65LVDS152DAR	TSSOP	DA	32	2000	350.0	350.0	43.0	

TEXAS INSTRUMENTS

www.ti.com

5-Dec-2023

TUBE



- B - Alignment groove width

*All dimensions are nominal

Device	Package Name	Package Type	Pins	SPQ	L (mm)	W (mm)	Τ (μm)	B (mm)
SN65LVDS152DA	DA	TSSOP	32	46	530	11.89	3600	4.9

IMPORTANT NOTICE AND DISCLAIMER

TI PROVIDES TECHNICAL AND RELIABILITY DATA (INCLUDING DATA SHEETS), DESIGN RESOURCES (INCLUDING REFERENCE DESIGNS), APPLICATION OR OTHER DESIGN ADVICE, WEB TOOLS, SAFETY INFORMATION, AND OTHER RESOURCES "AS IS" AND WITH ALL FAULTS, AND DISCLAIMS ALL WARRANTIES, EXPRESS AND IMPLIED, INCLUDING WITHOUT LIMITATION ANY IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE OR NON-INFRINGEMENT OF THIRD PARTY INTELLECTUAL PROPERTY RIGHTS.

These resources are intended for skilled developers designing with TI products. You are solely responsible for (1) selecting the appropriate TI products for your application, (2) designing, validating and testing your application, and (3) ensuring your application meets applicable standards, and any other safety, security, regulatory or other requirements.

These resources are subject to change without notice. TI grants you permission to use these resources only for development of an application that uses the TI products described in the resource. Other reproduction and display of these resources is prohibited. No license is granted to any other TI intellectual property right or to any third party intellectual property right. TI disclaims responsibility for, and you will fully indemnify TI and its representatives against, any claims, damages, costs, losses, and liabilities arising out of your use of these resources.

TI's products are provided subject to TI's Terms of Sale or other applicable terms available either on ti.com or provided in conjunction with such TI products. TI's provision of these resources does not expand or otherwise alter TI's applicable warranties or warranty disclaimers for TI products.

TI objects to and rejects any additional or different terms you may have proposed.

Mailing Address: Texas Instruments, Post Office Box 655303, Dallas, Texas 75265 Copyright © 2023, Texas Instruments Incorporated